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Premstaetten, April 27, 2017

PCN16-2017 (Second source for wafer fabrication)

Dear Mr. Cseh,

In order to reasonably protect the supply of your product "**AS5600**" and to ensure additional flexibility and capacity to further improve responsiveness and ontime delivery to our customers, ams AG is currently qualifying a supplemental source for wafer fabrication.

This will enable us to better support the ever increasing demand in today's dynamic market environment and to have an alternative and ready solution for possible capacity bottlenecks, allocation situations and any other manufacturing issues that may arise and potentially prevent ams AG from meeting our customer's demands on time.

The above mentioned devices, previously qualified at ams Fab B, will also be qualified at TSMC.

TSMC has been a qualified manufacturing partner of ams AG for years.

TSMC is certified in accordance with ISO9001. The technology (mixed signal 0,35um CMOS) is fully compatible to ams' technology.



This change covers only the wafer fabrication of the products.
Testing and backend services will remain unchanged.

Process Flow Matrix:

	<u>Current supply chain</u>	<u>New supply chain</u>
Wafer Fabrication	unchanged - ams fab B (Austria)	ams fab B (Austria) or TSMC
Wafer Probe Testing	unchanged - ams (Austria)	unchanged - ams (Austria)
Assembly	unchanged – at qualified assembly partners	unchanged – at qualified assembly partners
Final Testing and Packing	unchanged - ams (Austria) or ams (Philippines)	unchanged - ams – Austria or ams (Philippines)

Advantages:

ams' 0,35 CMOS technology is a TSMC licenced technology and matches therefore very well with TSMC's mixed signal CMOS process.

The following product versions will be affected:

<u>product</u>	<u>material ID</u>
AS5600-ASOT	191240005
AS5600-ASOM	191240012



Timing of change:

The supplemental wafer fabrication is fully qualified, the product specific qualification will be finished in Q3 / 2017. Material from TSMC fab will be delivered from Q4 / 2017 onwards.

Set of qualification tests:

ams qualified the wafer fabrication according to JEDEC standards.

Detailed results of the qualification will be available upon request.

On a product level we are going to do a characterization over temperature as well as ESD/LU tests.

If you do have further questions please do not hesitate to contact us.

Please be advised that unless we receive your written refusal concerning this PCN within 30 days, the PCN shall be deemed accepted.

Best regards,

A handwritten signature in black ink, appearing to read 'D. Gleispach'.

Dietmar Gleispach
ams AG
Director Operations
EAS & ISS